

TIMA[®] 5

Thermal Interface Material Analyzer
Model 5



NANOTEST

Berliner Nanotest und Design GmbH

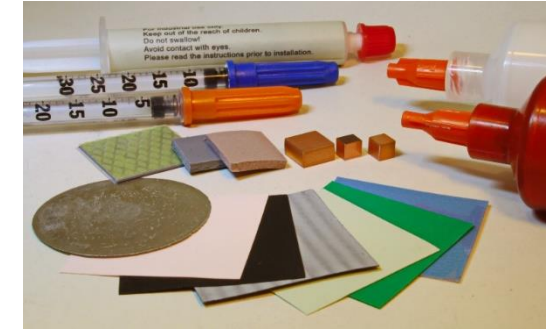


Beyond ASTM D 5470

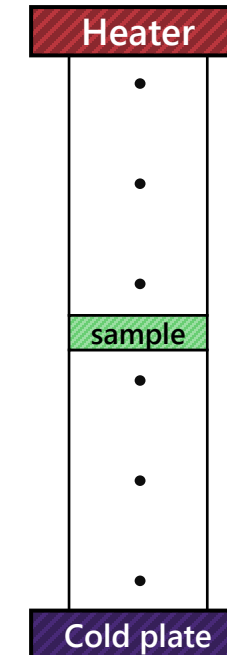
- » Effective and bulk thermal conductivity
- » Thermal effective and interface resistance
- » Compact all-in-one system

Feasible samples

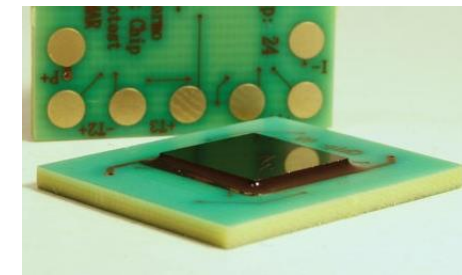
- » Thermal interface material
- » Die attach materials
- » Underfill materials
- » Molding compound
- » Substrates
- » Foils
- » Multilayer samples



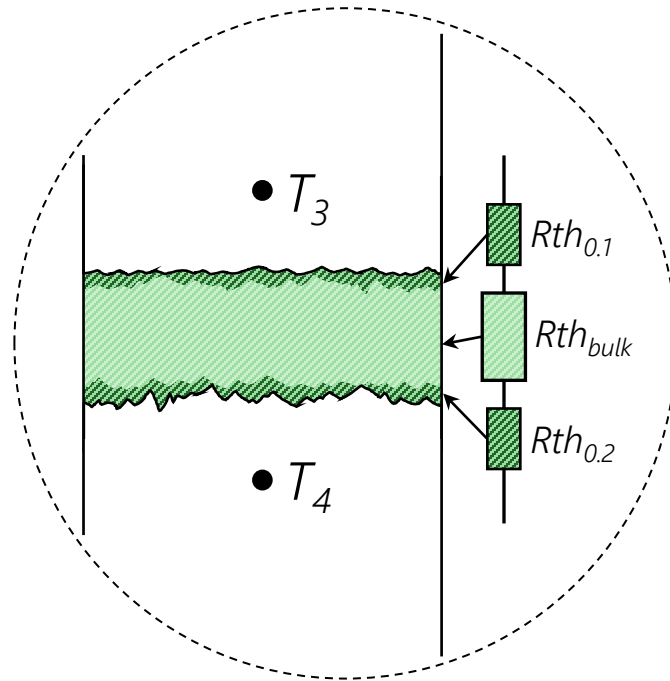
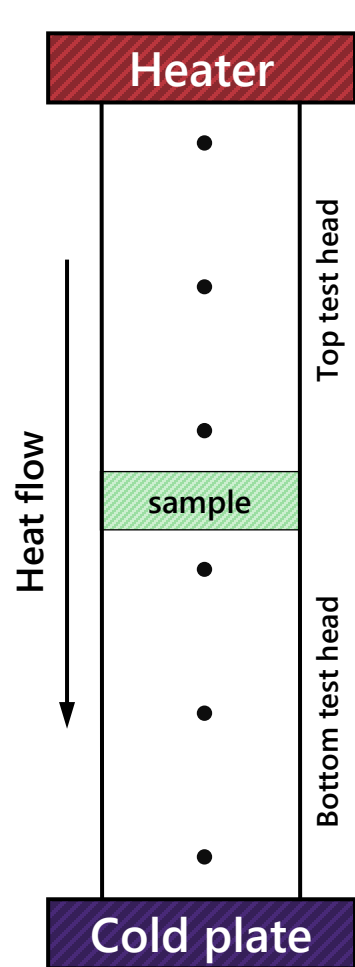
examples of feasible material samples



selection of available test heads

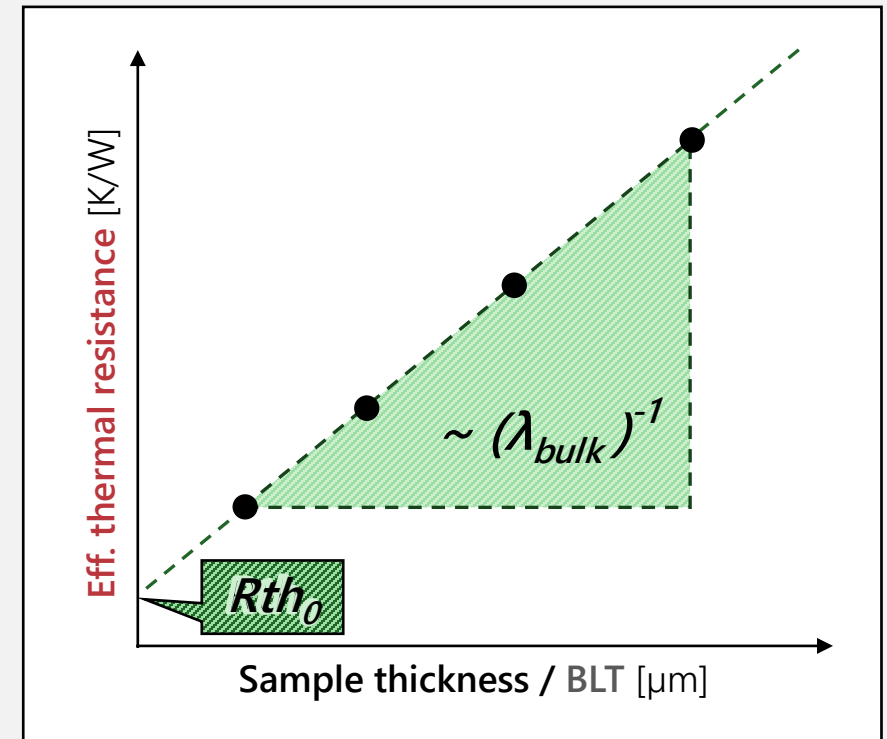


test chip for application-related studies



$$Rth_{eff} = Rth_{bulk} + Rth_0$$

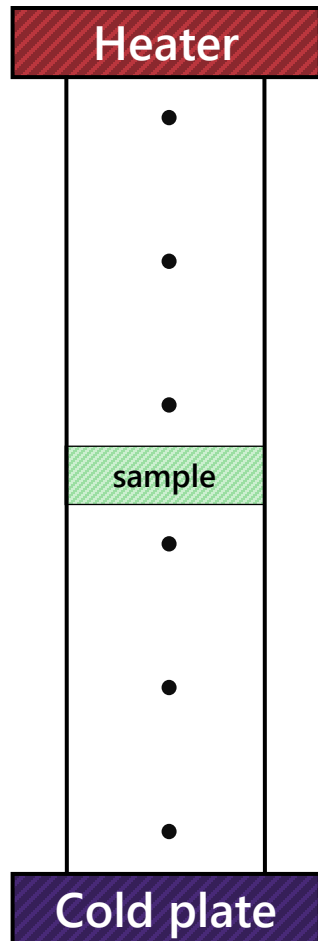
$$Rth_{eff} = \frac{\Delta T}{\dot{Q}}$$



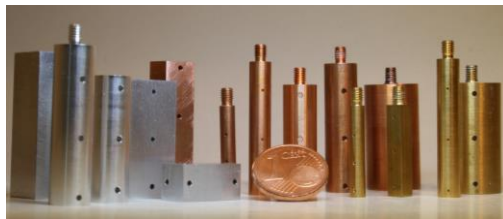
$$Rth_{eff} = \frac{1}{\lambda_{bulk} \cdot A} \cdot BLT + Rth_0$$

The linear fit of
thermal resistance over the *thickness*
 bears information about
bulk thermal conductivity and *interface resistance*.

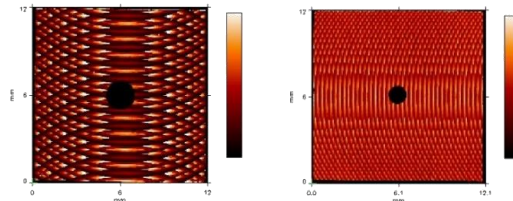
» Testing under application-related or customer-specific conditions



Test heads



Various **test heads materials** allow to mimic contacting surfaces from real application cases

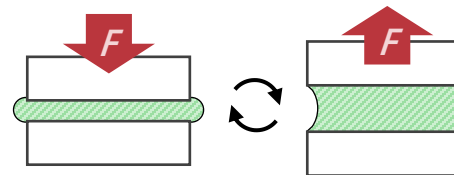


Manipulation of **surface coating** and **roughness** brings the test setup even closer to real application

Beyond the scope

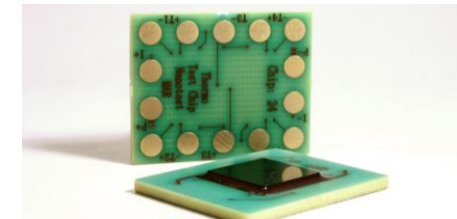


Specialized **curing tools** for external sample curing under any sample-specific condition

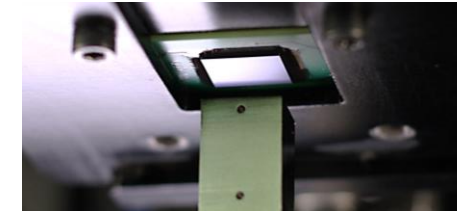


In-situ testing of **aging behavior**, lifetime expectancy and reliability of TIM under recurring loads

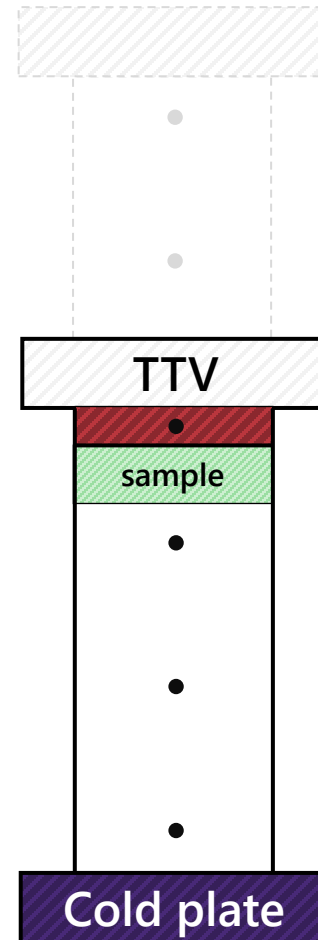
TIM1 testing

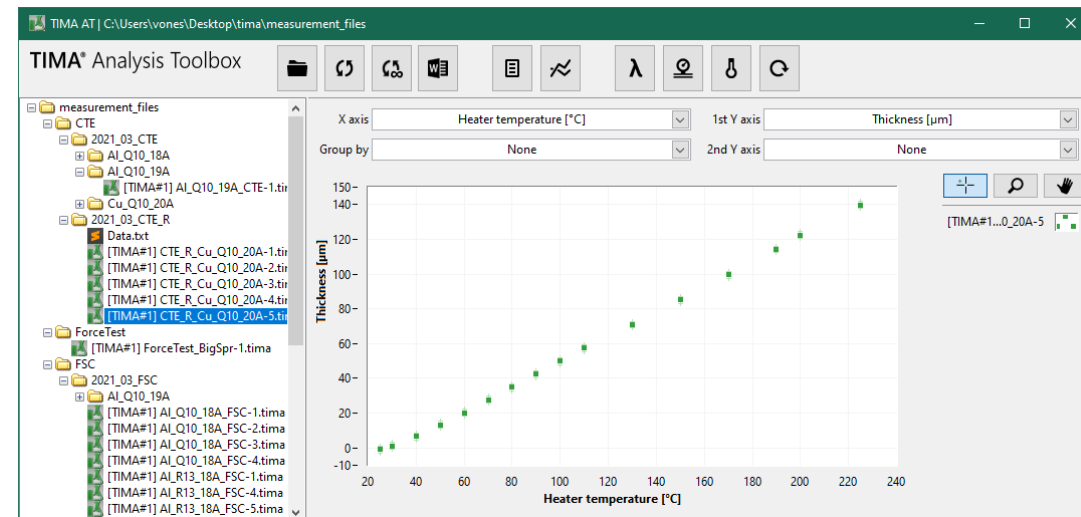
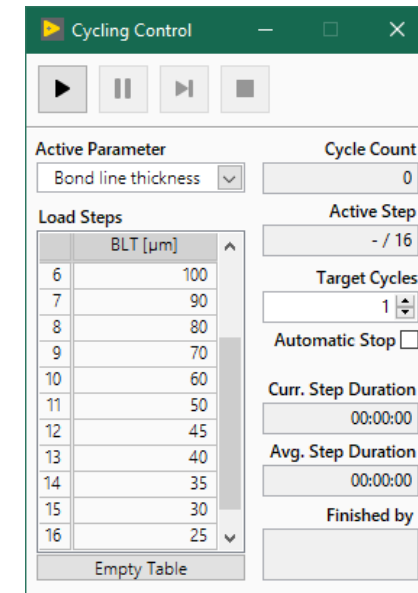
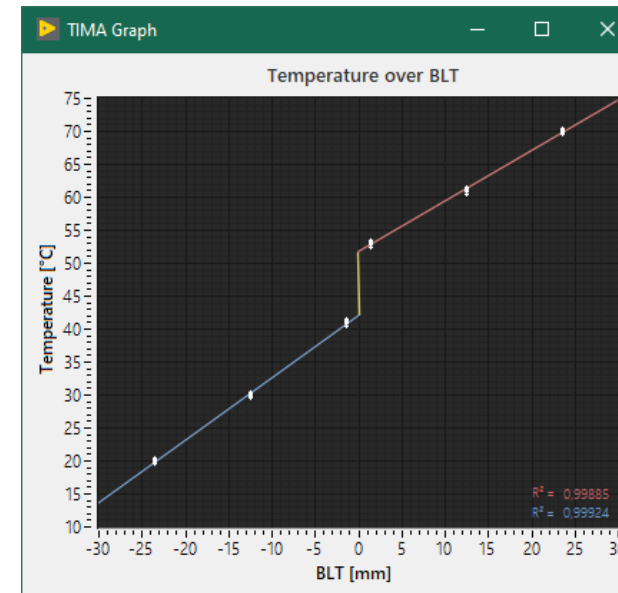
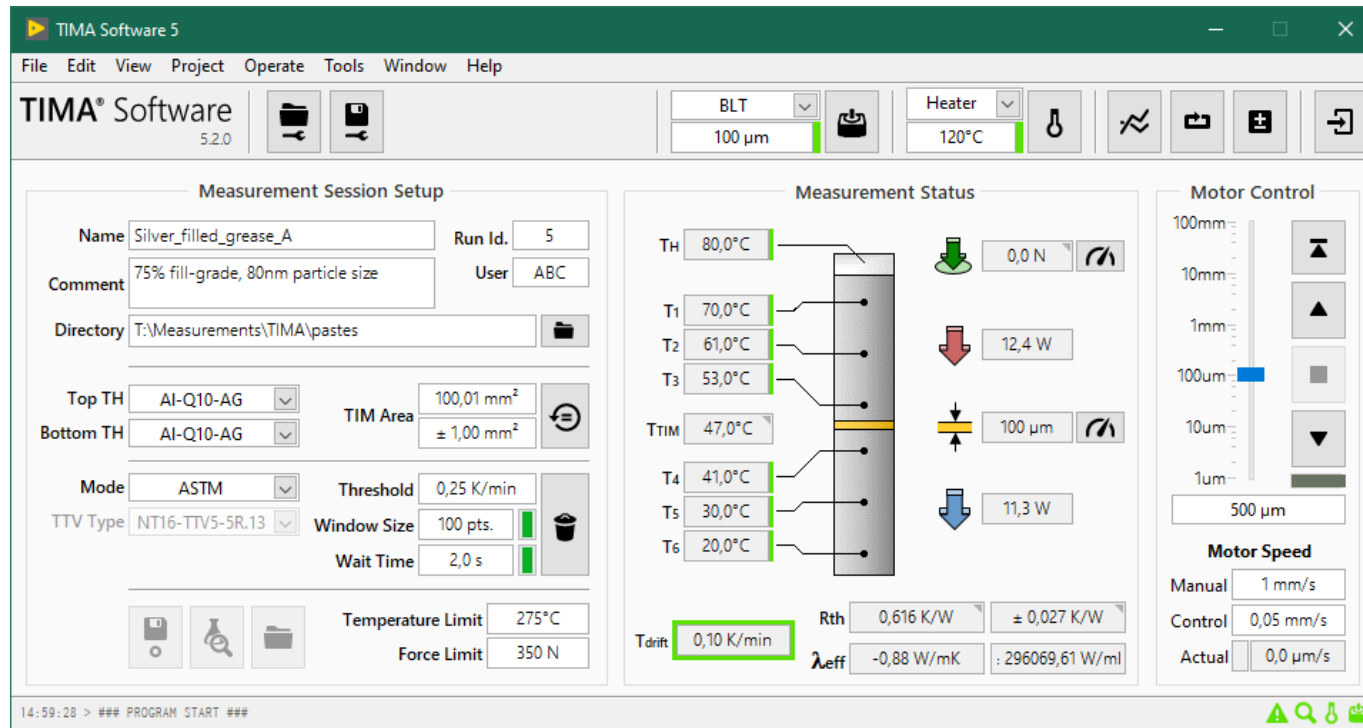


The **use of a TTV** instead of a metal top test head creates a typical TIM1 scenario



Interior of TIMA 5 is at any time **easily accessible** to always visually observe what is happening





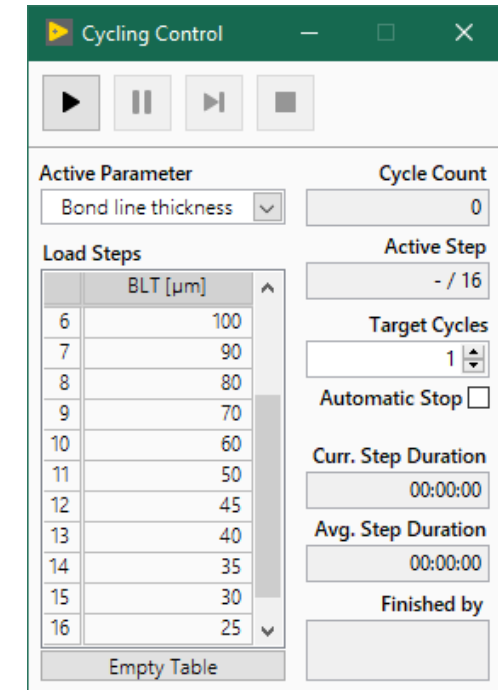
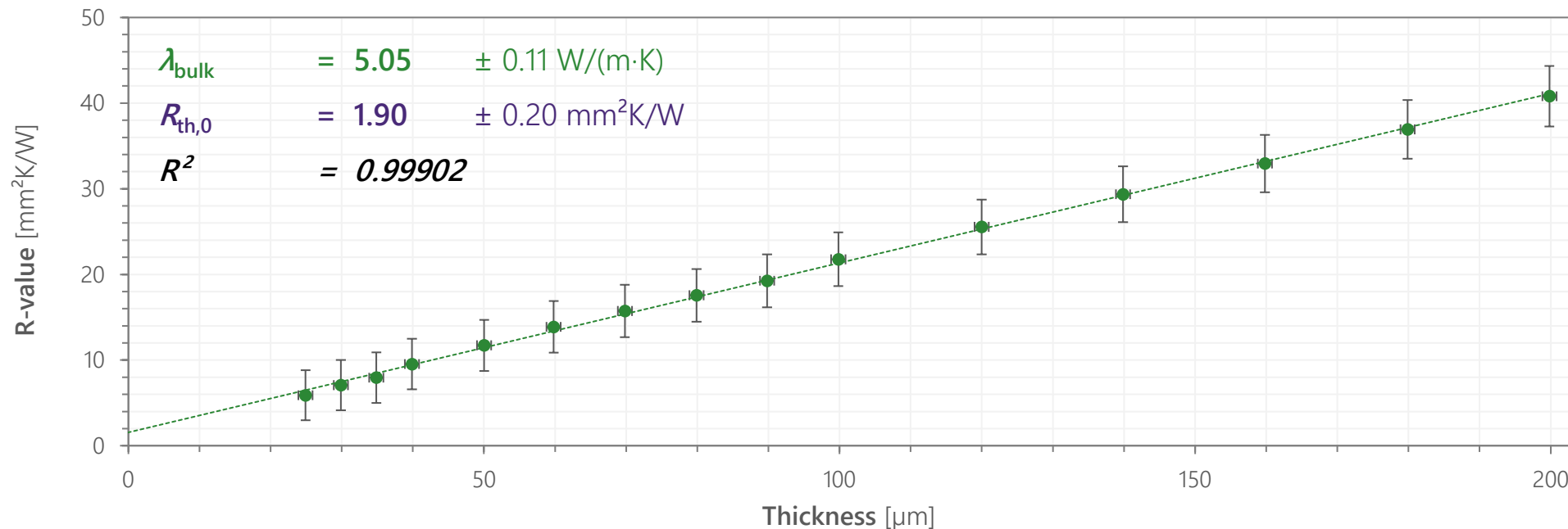
- » Live measurement monitoring
- » Full measurement setup control
- » Measurement setup save and restore
- » Quick measurement results review
- » Lean and intuitive design

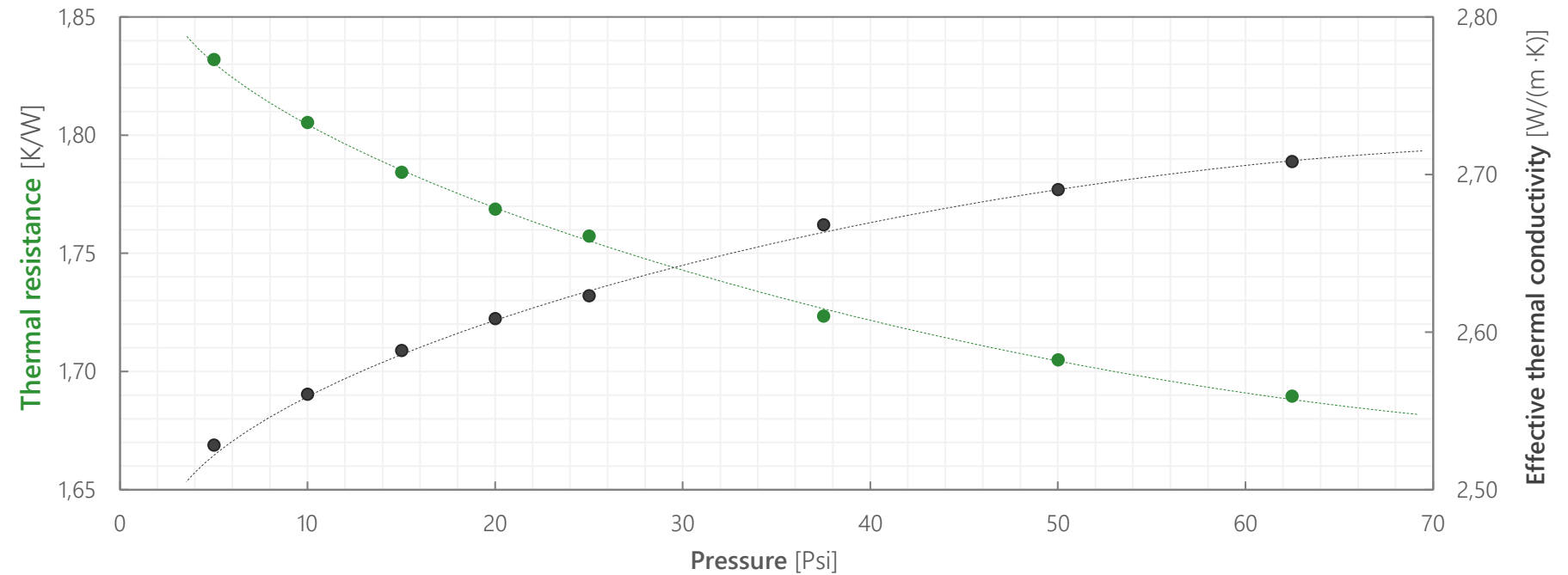
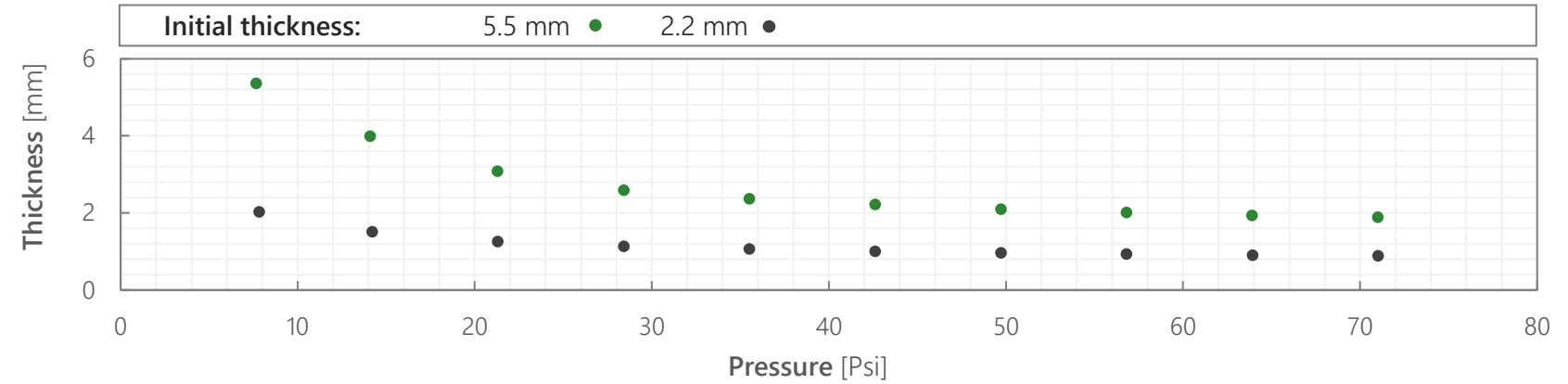
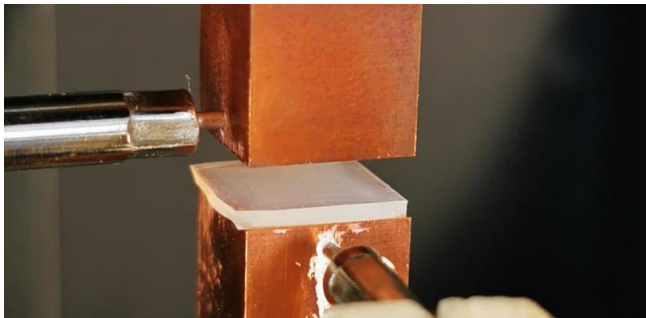
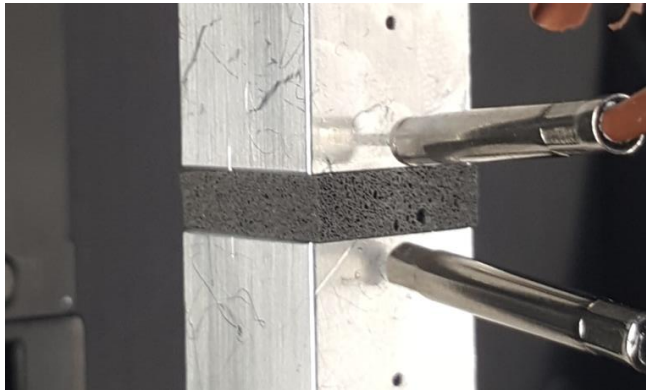
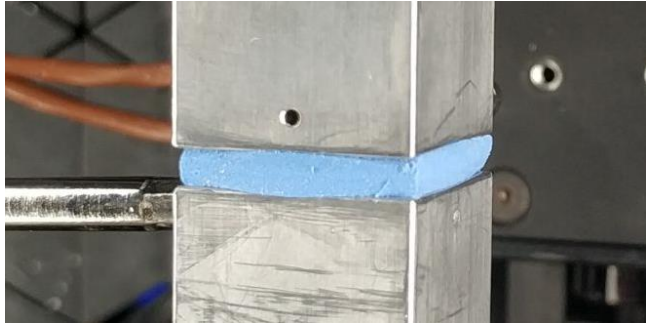
Measurement examples

TIMA® 5 in action

Silver-filled polymer

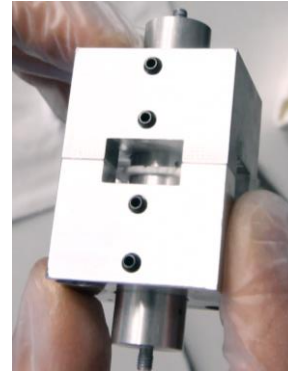
- › R-value vs. thickness
 - Bulk thermal conductivity and contact resistance
- › Thickness range 25 to 200 μm
 - Automatic scheduled measurement



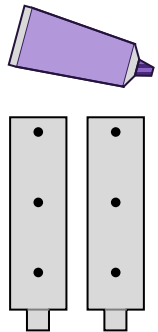


External curing of samples for measurement in TIMA

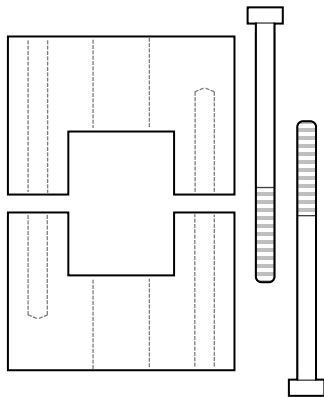
- » Low-stress bond lines
- » Defines bond line thicknesses
- » Easy assembling and disassembling



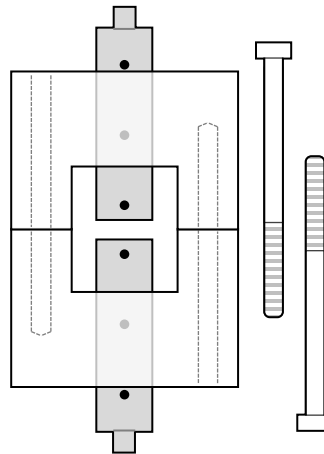
Test heads
& sample



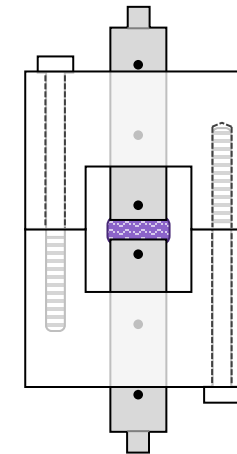
Curing tool



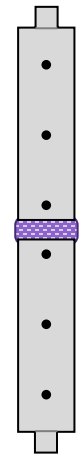
Setting defined BLT



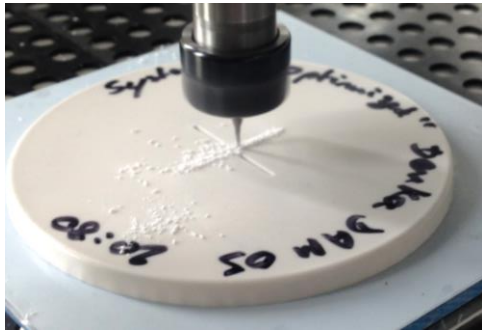
Assembly & curing



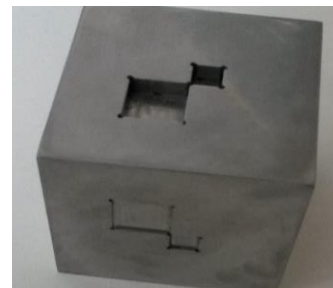
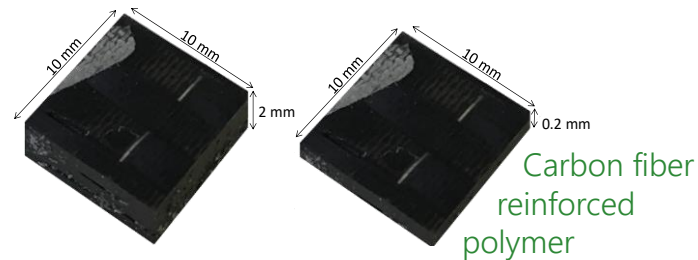
completed sample



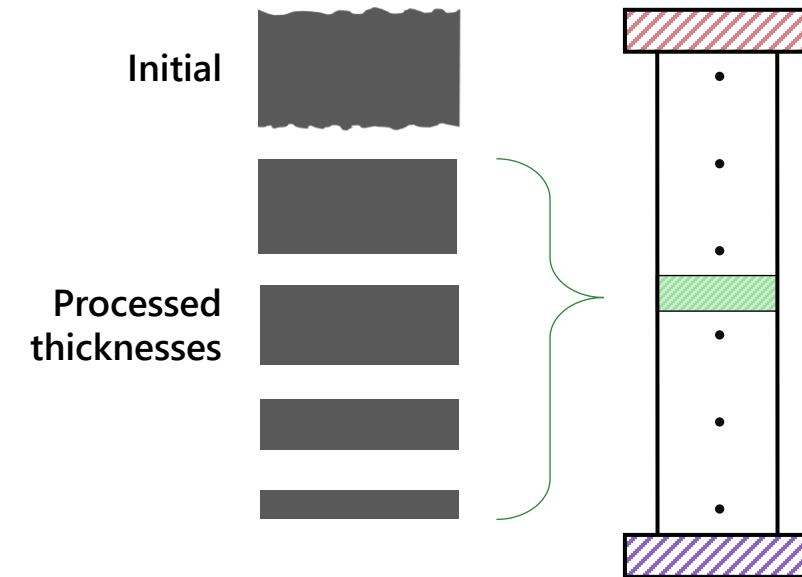
- » Bulk thermal conductivity determined by measurements at different thicknesses
- » ASTM D5470 conformant
- » **Iterative thinning** and measurement of same sample
- » Characterization of **pre-cured samples**



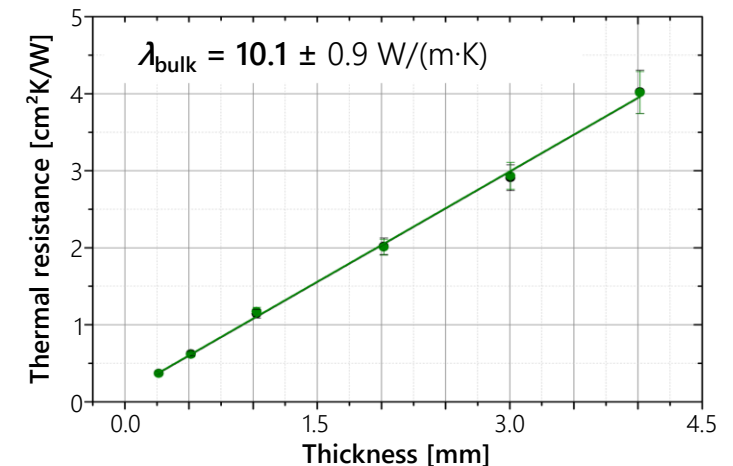
Underfill material

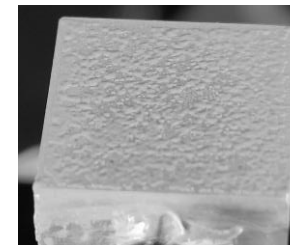
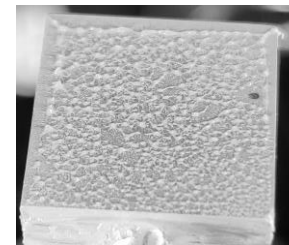
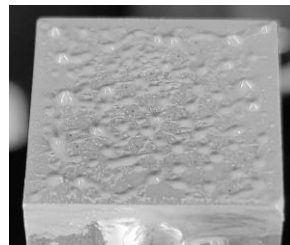
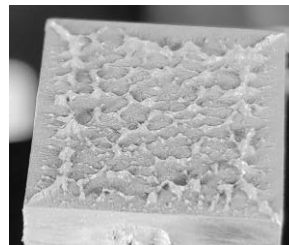
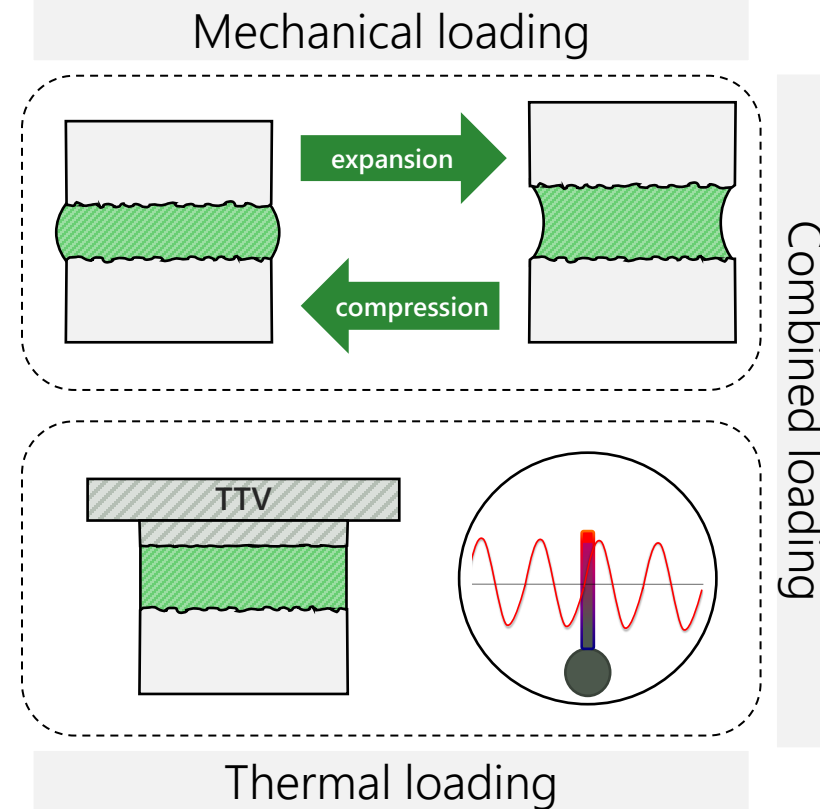


Sample preparation tool



Bulk thermal conductivity of highly conductive polymer





Long-term testing

- » High-temperature duration test
- » In-situ curing characterization

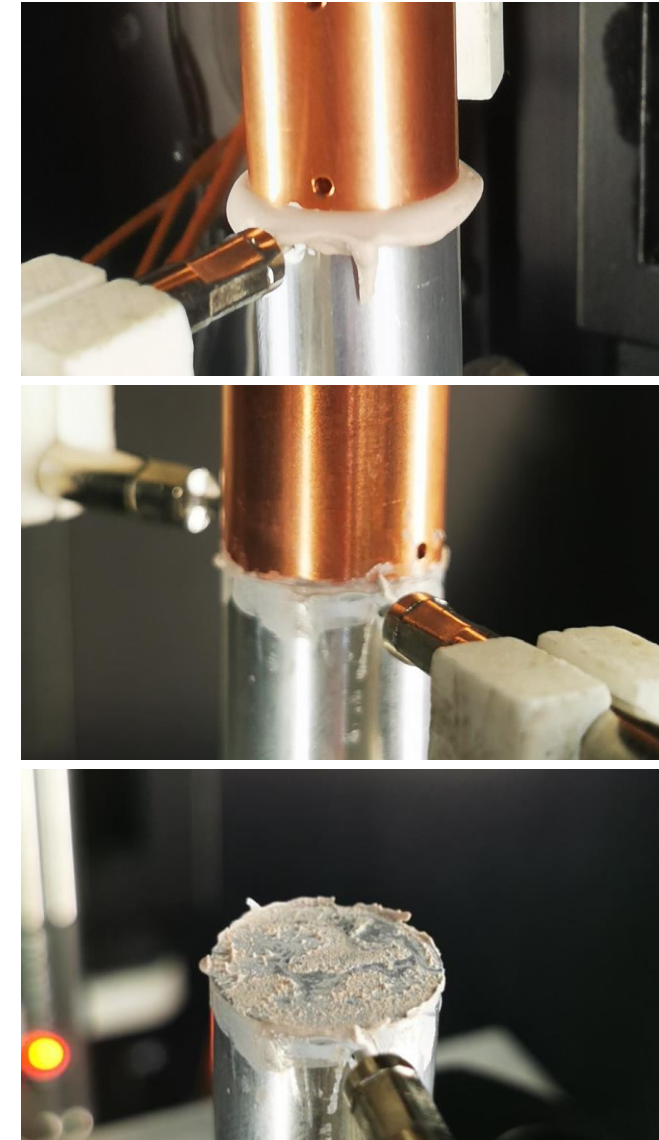
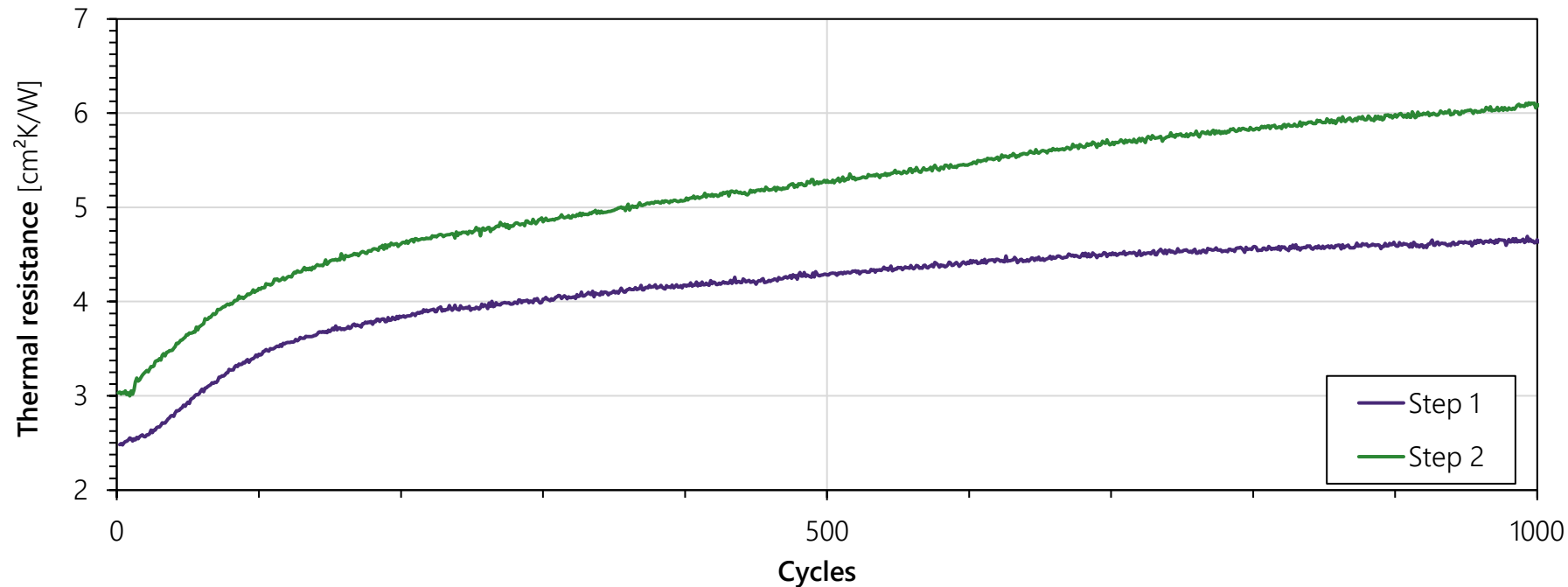
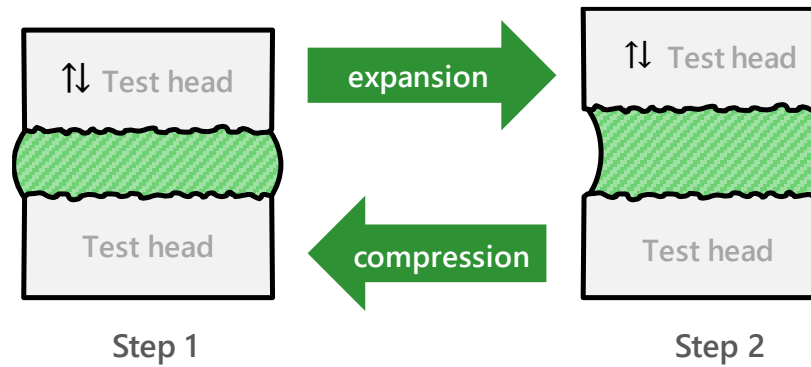
Mechanical loading

- » Cyclic thickness variation
- » Compression & decompression
- » Repeated tension and release
- » Long-term compression

Thermal loading

- » Temperature cycling
- » TIM1 power profile cycling

- » Initial thickness of 300 μm
- » 80°C sample temperature
- » +10% gap width variation
- » 90% R_{th} increase
- » Pump-out and dry-out effect



The System Key Characteristics


- » Highly compact
- » Robust and user-friendly
- » Comprehensive
 - › Bulk & eff. thermal conductivity
 - › Effective and interface resistance
 - › Pressure dependence
 - › Temperature dependence
 - › Process dependence
- » Full ASTM D 5470 coverage
- » Up to 150°C sample temp.
- » 300 N clamping or tensile force

The Edge Unique Selling Points

- » Automated testing
- » Custom contacting surfaces
- » Cured material characterization
 - › Adhesives
 - › Resins
 - › Gap fillers
- » Phase change material testing
- » In-situ aging investigations
- » Burn-in testing



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